

# Ceramic Trimmer Capacitors



## TZB4 Series

### ■ Features

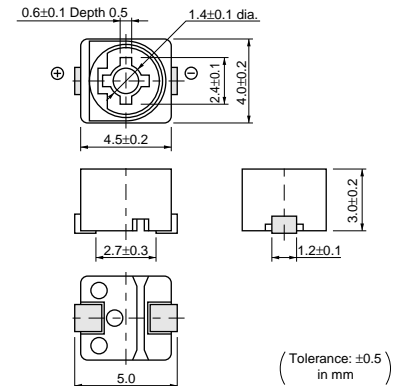
1. Miniature rectangular shape:  
4.0(W)x4.5(L)x3.0(H)mm
2. Color coded case facilitates identification of capacitance range.
3. Designed for automatic placement in surface mount applications.
4. Designed to withstand flux baths and solder baths (with cover film type)
5. Can be temporarily attached to PCB with adhesives (Terminal style A and B)
6. Can be reflow and flow (with cover film type) soldering method
7. Stable characteristics over a wide frequency range (Resonant frequency: 1000MHz min. / 6pF)

### ■ Applications

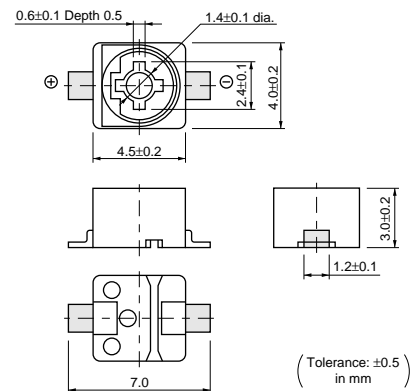
- |                                 |                         |
|---------------------------------|-------------------------|
| 1. Car audio systems            | 2. Cordless telephones  |
| 3. Hybrid ICs                   | 4. Pagers               |
| 5. Remote keyless entry systems |                         |
| 6. Tuner packs                  | 7. Surveillance cameras |
| 8. DVDs                         | 9. Burglarproof devices |



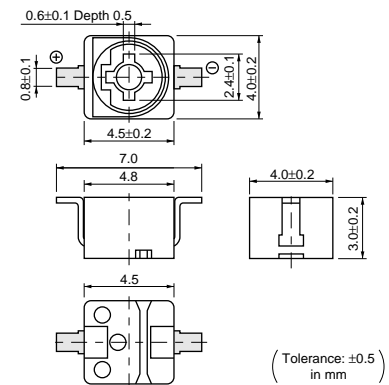
A Type



B Type



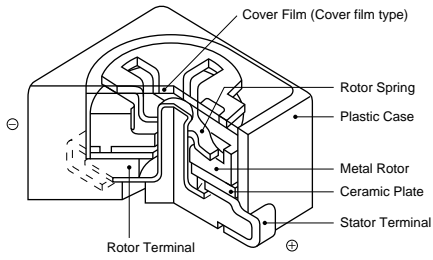
E Type



Part Number	C min. (max.) (pF)	C max. (pF)	TC	Q	Rated Voltage	Withstanding Voltage	Stator/Case Color
TZB4Z030□□10	1.4	3.0 +50/-0%	NP0±200ppm/°C	300min. at 1MHz, Cmax	100Vdc	220Vdc	Brown
TZB4Z060□□10	2.0	6.0 +50/-0%	NP0±200ppm/°C	500min. at 1MHz, Cmax.	100Vdc	220Vdc	Blue
TZB4Z100□□10	3.0	10.0 +50/-0%	NP0±300ppm/°C	500min. at 1MHz, Cmax.	100Vdc	220Vdc	White
TZB4R200□□10	4.5	20.0 +50/-0%	N750±400ppm/°C	500min. at 1MHz, Cmax	100Vdc	220Vdc	Red
TZB4P300□□10	6.5	30.0 +50/-0%	N1200±500ppm/°C	300min. at 1MHz, Cmax	100Vdc	220Vdc	Green
TZB4P400□□10	8.5	40.0 +50/-0%	N1200±500ppm/°C	300min. at 1MHz, Cmax	100Vdc	220Vdc	Yellow
TZB4Z250□□10	4.0	25.0 +100/-0%	NP0±300ppm/°C	300min. at 1MHz, Cmax.	50Vdc	110Vdc	Black+Marking
TZB4R500□□10	7.0	50.0 +100/-0%	N750±300ppm/°C	300min. at 1MHz, Cmax	50Vdc	110Vdc	Black+Marking

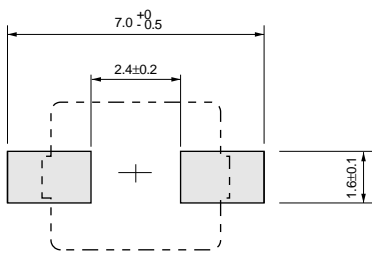
Insulation Resistance: 10000M ohm Torque: 1.5 to 9.8mNm Operating Temperature Range: -25 to +85°C  
 First blank: Terminal Type Second blank: Cover film codes (A: not provided, B: provided)  
 ex. TZB4Z100AB10: Terminal Type is A, and Cover film is provided.

## Construction



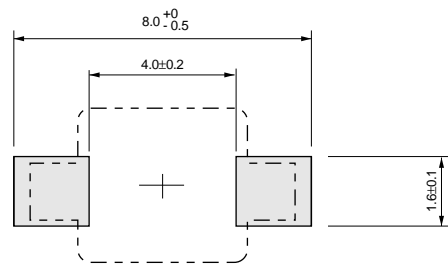
## Land Pattern/Mounting Holes

A Type



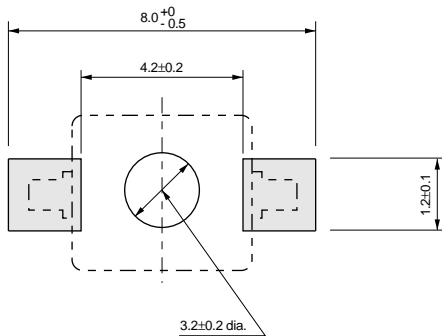
(in mm)

B Type



(in mm)

E Type



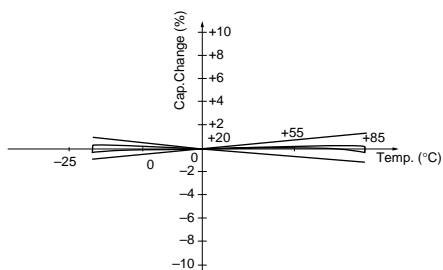
(in mm)

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## Temperature Characteristics

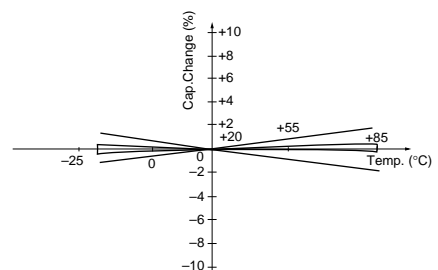
TZB4Z060

Z060 (NP0±200ppm/°C)



TZB4Z100

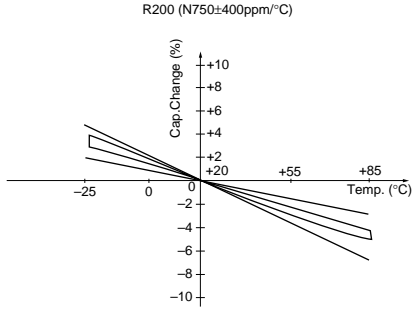
Z100 (NP0±300ppm/°C)



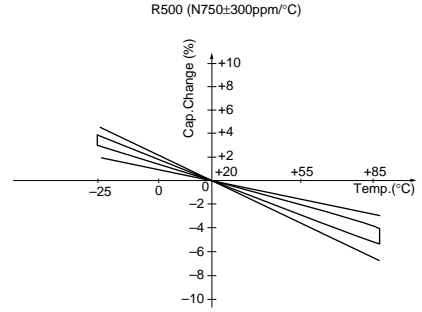
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## Temperature Characteristics

TZB4R200

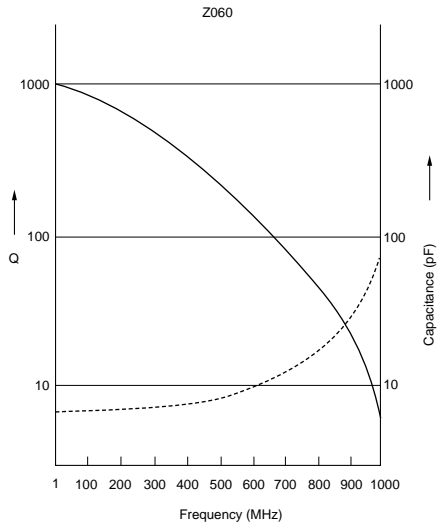


TZB4R500

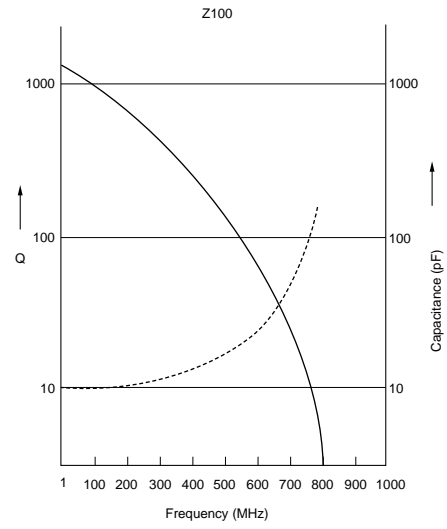


## Frequency Characteristics

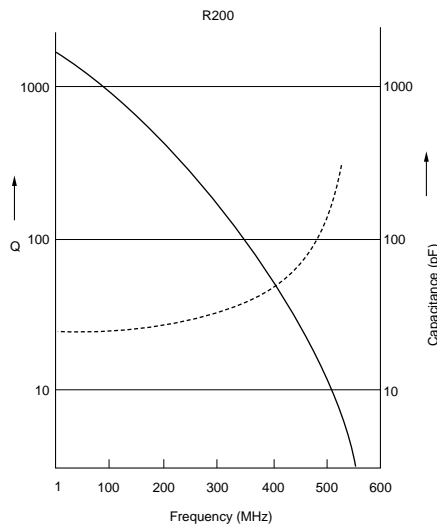
TZB4Z060



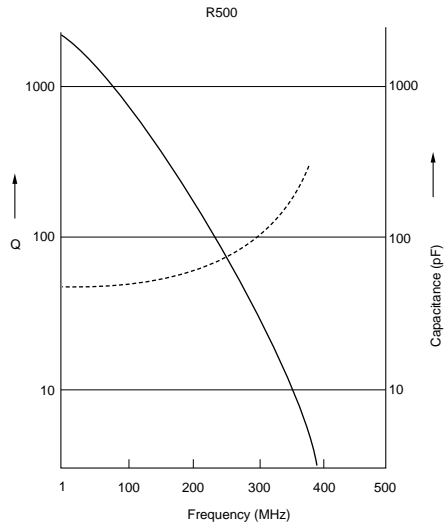
TZB4Z100



TZB4R200



TZB4R500



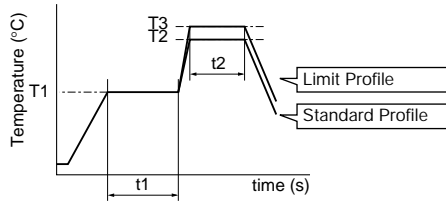
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## Temperature Profile

### Flow Soldering Profile

Soldering profile for Lead-free solder (96.5Sn/3Ag/0.5Cu), Eutectic solder (63Sn/37Pb)



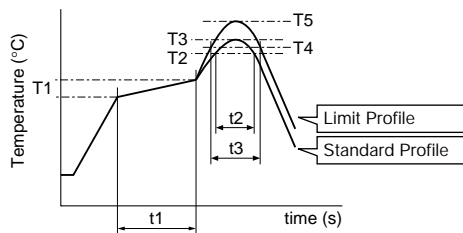
• Immerse the body in solder bath, available for cover film type.

Standard Profile				
Pre-heating		Heating		Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)	
150°C	60 to 120sec.	250°C	5sec. max.	1 time

Limit Profile				
Pre-heating		Heating		Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T3)	Time (t2)	
150°C	60 to 120sec.	265±3°C	5sec. max.	2 times

### Reflow Soldering Profile

① Soldering profile for Lead-free solder (96.5Sn/3Ag/0.5Cu)



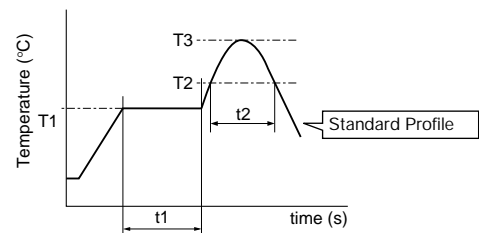
Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150 to 180°C	60 to 120sec.	220°C	30 to 60sec.	245±3°C	2 times

Limit Profile					
Pre-heating		Heating		Peak temperature (T5)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T4)	Time (t3)		
150 to 180°C	60 to 120sec.	230°C	30 to 50sec.	260 +5/-0°C	2 times

• Available for terminal shape A, B, and E..

② Soldering profile for Eutectic solder (63Sn/37Pb)

(Limit profile: refer to ①)



Standard Profile					
Pre-heating		Heating		Peak temperature (T3)	Cycle of reflow
Temp. (T1)	Time (t1)	Temp. (T2)	Time (t2)		
150°C	60 to 120sec.	183°C	30sec.	230 +5/-0°C	1 time

### Solder Iron

Standard Profile			
Temperature of soldering iron tip	Soldering time	Soldering iron power output	Cycle of solder iron
350±10°C	3sec. max.	30W max.	1 time

### Notice (Storage and Operating Condition)

- Do not use the trimmer capacitor under atmosphere of RTV silicone rubber (Room Temperature Vulcanizing Silicone Rubber) except Acetone liberating silicone sealant.
- Before using trimmer capacitor, please store under the condition of -10 to +40 degrees C and 30 to 85%RH.
- Do not store in or near corrosive gasses.
- Use within 6 months of delivery.
- Do not store under direct sunlight.
- Do not use the trimmer capacitor under the conditions listed below.
  - Corrosive gasses atmosphere (ex. Chlorine gas, Hydrogen sulfide gas, Ammonia gas, Sulfuric acid gas, Nitric oxide gas, etc.)
  - In liquid (ex. water, oil, medical liquid, organic solvent, etc.)
  - Dusty / dirty atmosphere
  - Direct sunlight
  - Static voltage nor electric/magnetic fields
  - Direct sea breeze
  - Other variations of the above

## ■ Notice (Soldering and Mounting)

### 1. Soldering

- (1) Can be soldered by reflow soldering method, flow soldering method, and soldering iron.
- (2) Soldering condition  
Refer to the temperature profile.  
If the soldering conditions are not suitable, e.g., excessive time and/or excessive temperature, the trimmer capacitor may deviate from the specified characteristics.
- (3) The amount of solder is critical.
- (4) The thickness of solder paste should be printed from 150 micro m to 200 micro m and the dimension of land pattern should be Murata's standard land pattern used at reflow soldering. Insufficient amounts of solder can lead to insufficient soldering strength on PCB. Excessive amounts of solder may cause bridging between the terminals or contact failure due to flux wicking up.
- (5) When using soldering iron, the string solder should be applied to the lower part of the terminal only. Do not apply flux except to the terminals. Excessive amounts of solder and/or applying solder to the upper part of the terminal may cause fixed rotor or contact failure due to flux invasion into the movable part and/or the contact point. The soldering iron should not come in contact with the plastic case of the trimmer capacitor. If such contact does occur, the trimmer capacitor may be damaged.
- (6) Our recommended chlorine content of solder is as follows.
  - (a) Solder paste: 0.2wt% max.
  - (b) String solder: 0.5wt% max.

- (7) Do not use water-soluble flux (for water cleaning). To prevent the deterioration of trimmer capacitor characteristics, apply flux only to terminals.

### 2. Mounting

- (1) Do not apply excessive force (preferably 5.0N [Ref: 500gf] max.), when the trimmer capacitor is mounted on the PCB.
- (2) Do not warp and/or bend PCB to prevent trimmer capacitor from breakage.
- (3) In case of bending the terminals, do not apply excessive force to the body of the product and prevent the terminal fixing part from damaging.
- (4) Use the suitable dimension of the pick-up nozzle.
  - > Without cover film type
    - External dimensions of 4.5x4.0mm and 2.5mm bore diameter.
  - > With cover film type
    - 4.0mm external diameter and 2.0mm bore diameter.

### 3. Cleaning [with cover film type]

Isopropyl alcohol and Ethyl alcohol are available material for cleaning. If you use any other types of solvents, please evaluate performance by your set. Moreover, please confirm no damage for trimmer capacitor after cleaning by your conditions.

### 4. Other

Note the polarity of the trimmer capacitor to minimize influence by stray capacitance.  
(Refer to the dimensions concerning the polarity.)

## ■ Notice (Handling)

1. Use suitable screwdrivers that fit comfortably in driver slot.

- (1) Recommended screwdriver for manual adjustment  
MURATA: KMDR010
- (2) Recommended screwdriver bit for automatic adjustment  
MURATA: KMBT010

2. When adjusting with a screwdriver, do not apply excessive force (preferably 1.0 N [Ref: 100gf] max.) to minimize capacitance drift. If excessive force is applied to the screwdriver slot, it may cause deformation of the products.

3. Do not apply adhesive, lock paints, or any other substances to the trimmer capacitor to secure the rotor position. They may cause corrosion or electrical contact problems.

4. Do not break the cover film before the completion of PCB mounting, soldering, and cleaning.

5. Do not clean the trimmer capacitor after the cover film has been broken.

6. To break the cover film, first turn the screwdriver more than 360 deg., and set the capacitance value. (Only inserting the screwdriver cannot break the cover film.)

## ■ Notice (Other)

Before using trimmer capacitor, please test after assembly in your particular mass production system.